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PATENT
Docket No. 204552021700

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of:

Tetsuyoshi INOUE

Serial No.: 09/987,010

Filing Date: November 13, 2001

For: SEMICONDUCTOR LASER
MANUFACTURING METHOD AND
SEMICONDUCTOR LASER

Examiner: Tuan N. Nguyen

Group Art Unit: 2828

RESPONSE UNDER 37 CFR 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Action dated June 17, 2004, applicant respectfully requests reconsideration of this application in light of the following remarks.

REMARKS

Claims 1-6 are pending in the application.

The Examiner rejected claims 1 and 5¹ under 35 USC 102(e) as anticipated by Kotato U.S. Patent No. 6,099,678. Applicant respectfully traverses this rejection. Kotato neither discloses nor suggests the part of claim 1 where "the semiconductor laser chip is kept pressurized

¹ Applicant questions how the Examiner can reject claim 5 as anticipated without as well rejecting its base claim, independent claim 2, as anticipated. Applicant cannot surmise from the Action that the Examiner also intended to reject claim 2 as anticipated in view of the separate rejection of claim 2 for obviousness. The Examiner may and should withdraw the anticipation rejection of claim 5 on this ground alone.